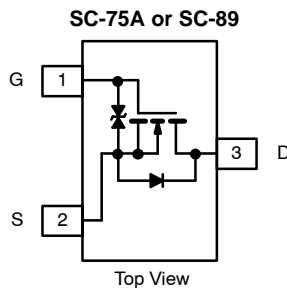


N-Channel 1.8-V (G-S) MOSFET

PRODUCT SUMMARY

| V _{DS} (V) | r _{DS(on)} (Ω) | I _D (mA) |
|---------------------|--------------------------------|---------------------|
| 20 | 0.70 @ V _{GS} = 4.5 V | 600 |
| | 0.85 @ V _{GS} = 2.5 V | 500 |
| | 1.25 @ V _{GS} = 1.8 V | 350 |



ORDERING INFORMATION

| Part Number | Package | Marking Code |
|--|---------------------|--------------|
| Si1012R-T1 Si1012R-T1—E3 (Lead (Pb)-Free) | SC-75A (SOT-416) | C |
| Si1012X-T1 Si1012X-T1—E3 (Lead (Pb)-Free) | SC-89 (SOT-490) | A |

FEATURES

- TrenchFET® Power MOSFET: 1.8-V Rated
- Gate-Source ESD Protected: 2000 V
- High-Side Switching
- Low On-Resistance: 0.7 Ω
- Low Threshold: 0.8 V (typ)
- Fast Switching Speed: 10 ns



Pb-free
Available

BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)

| Parameter | Symbol | 5 secs | Steady State | Unit | |
|--|-----------------------------------|-----------------------|--------------|------|----|
| Drain-Source Voltage | V _{DS} | 20 | | V | |
| Gate-Source Voltage | V _{GS} | ±6 | | | |
| Continuous Drain Current (T _J = 150°C) ^b | I _D | T _A = 25°C | 600 | 500 | mA |
| | | T _A = 85°C | 400 | 350 | |
| Pulsed Drain Current ^a | I _{DM} | 1000 | | | |
| Continuous Source Current (diode conduction) ^b | I _S | 275 | 250 | | |
| Maximum Power Dissipation ^b for SC-75 | P _D | T _A = 25°C | 175 | 150 | mW |
| | | T _A = 85°C | 90 | 80 | |
| Maximum Power Dissipation ^b for SC-89 | P _D | T _A = 25°C | 275 | 250 | |
| | | T _A = 85°C | 160 | 140 | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to 150 | | °C | |
| Gate-Source ESD Rating (HBM, Method 3015) | ESD | 2000 | | V | |

Notes

- d. Pulse width limited by maximum junction temperature.
e. Surface Mounted on FR4 Board.

| SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) | | | | | | |
|---|--------------|--|------|-----------|-----------|---------------|
| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$ | 0.45 | | 0.9 | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\ \text{V}, V_{GS} = \pm 4.5\ \text{V}$ | | ± 0.5 | ± 1.0 | μA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 20\ \text{V}, V_{GS} = 0\ \text{V}$ | | 0.3 | 100 | nA |
| | | $V_{DS} = 20\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 85^\circ\text{C}$ | | | 5 | μA |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} = 5\ \text{V}, V_{GS} = 4.5\ \text{V}$ | 700 | | | mA |
| Drain-Source On-State Resistance ^a | $r_{DS(on)}$ | $V_{GS} = 4.5\ \text{V}, I_D = 600\ \text{mA}$ | | 0.41 | 0.70 | Ω |
| | | $V_{GS} = 2.5\ \text{V}, I_D = 500\ \text{mA}$ | | 0.53 | 0.85 | |
| | | $V_{GS} = 1.8\ \text{V}, I_D = 350\ \text{mA}$ | | 0.70 | 1.25 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 10\ \text{V}, I_D = 400\ \text{mA}$ | | 1.0 | | S |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 150\ \text{mA}, V_{GS} = 0\ \text{V}$ | | 0.8 | 1.2 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 10\ \text{V}, V_{GS} = 4.5\ \text{V}, I_D = 250\ \text{mA}$ | | 750 | | pC |
| Gate-Source Charge | Q_{gs} | | | 75 | | |
| Gate-Drain Charge | Q_{gd} | | | 225 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 10\ \text{V}, R_L = 47\ \Omega$ $I_D \cong 200\ \text{mA}, V_{GEN} = 4.5\ \text{V}, R_G = 10\ \Omega$ | | 5 | | ns |
| Rise Time | t_r | | | 5 | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 25 | | |
| Fall Time | t_f | | | 11 | | |

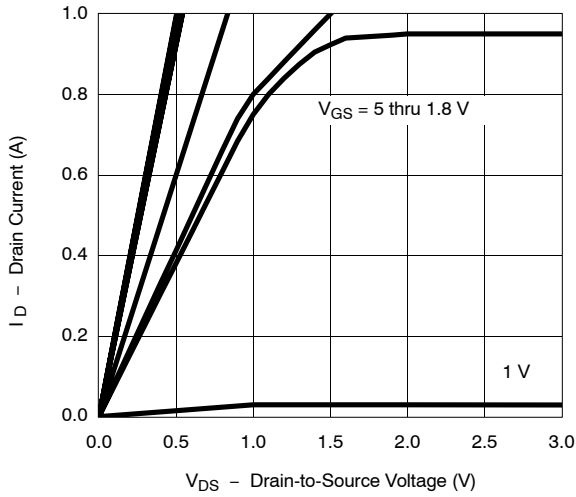
Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

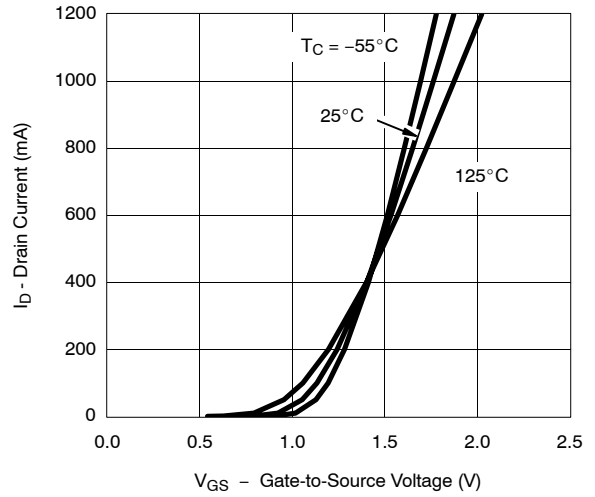
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS NOTED)

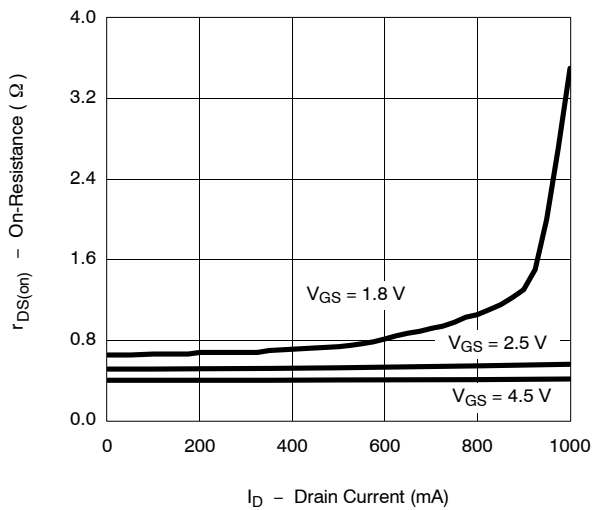
Output Characteristics



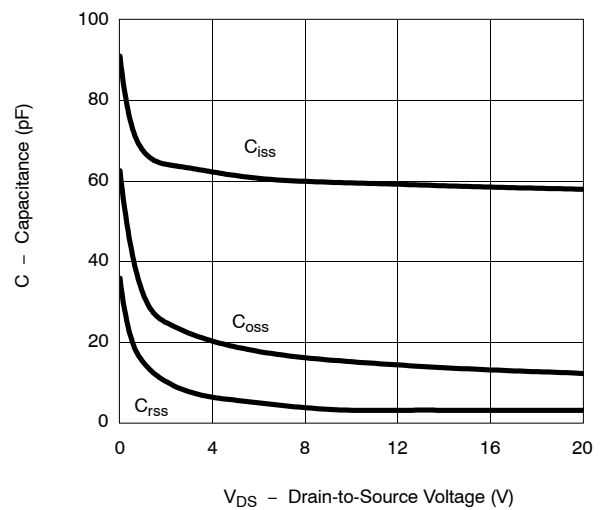
Transfer Characteristics



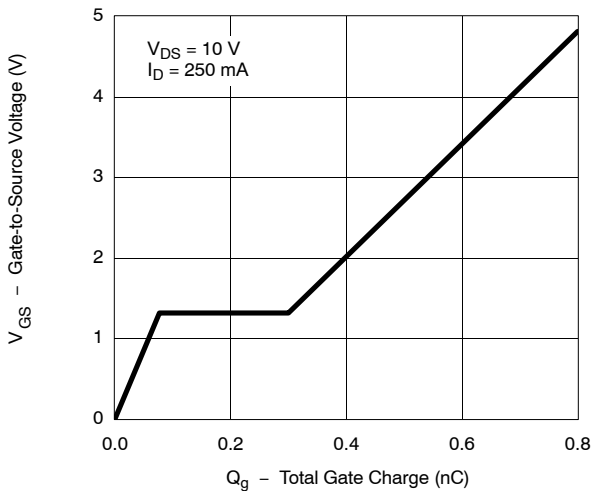
On-Resistance vs. Drain Current



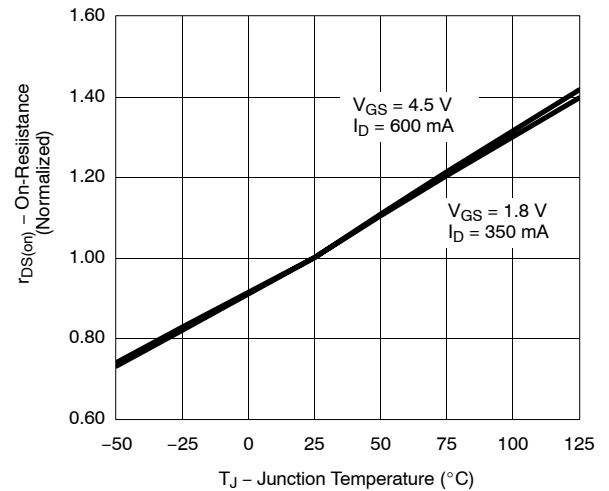
Capacitance



Gate Charge

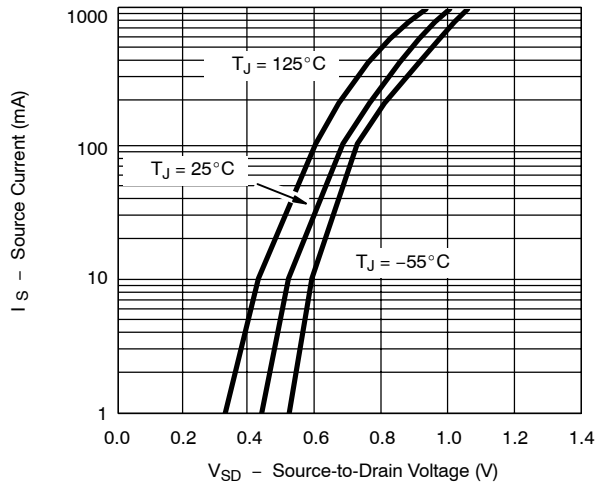


On-Resistance vs. Junction Temperature

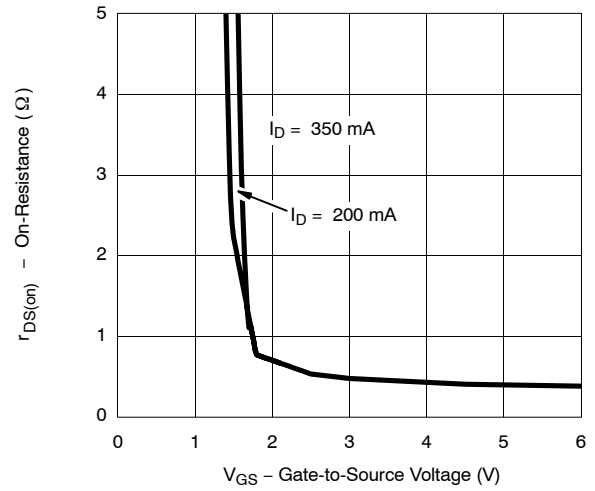


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS NOTED)

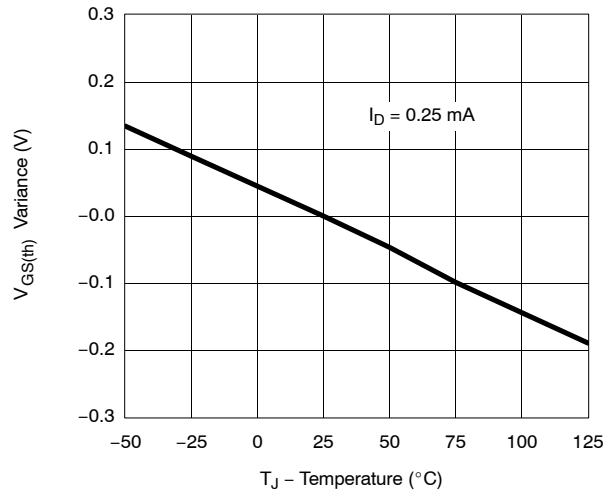
Source-Drain Diode Forward Voltage



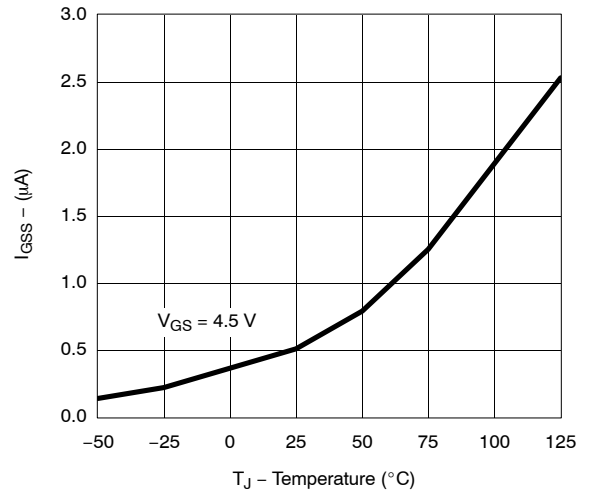
On-Resistance vs. Gate-to-Source Voltage



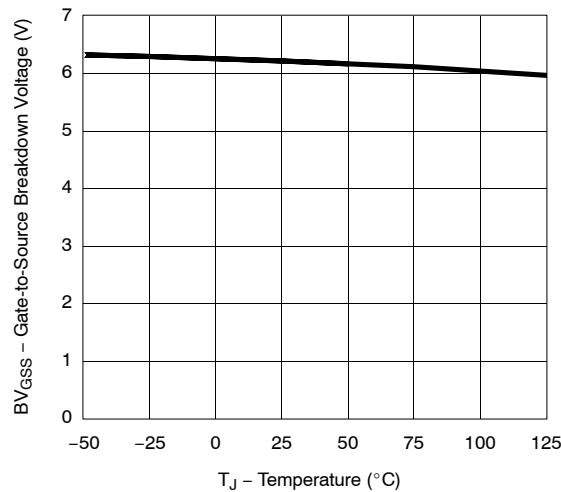
Threshold Voltage Variance vs. Temperature



I_{GSS} vs. Temperature

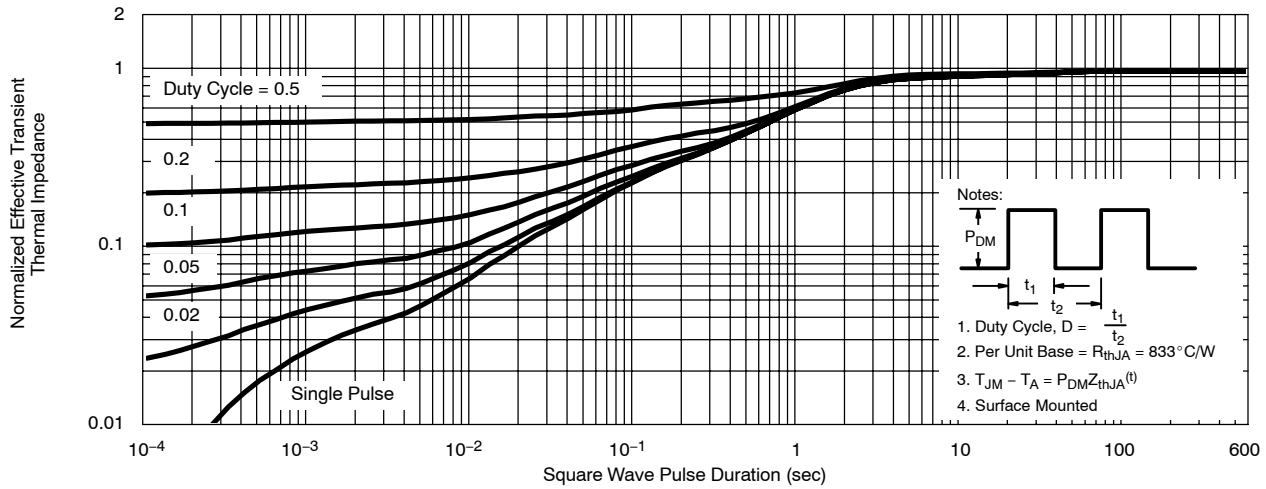


BV_{GSS} vs. Temperature

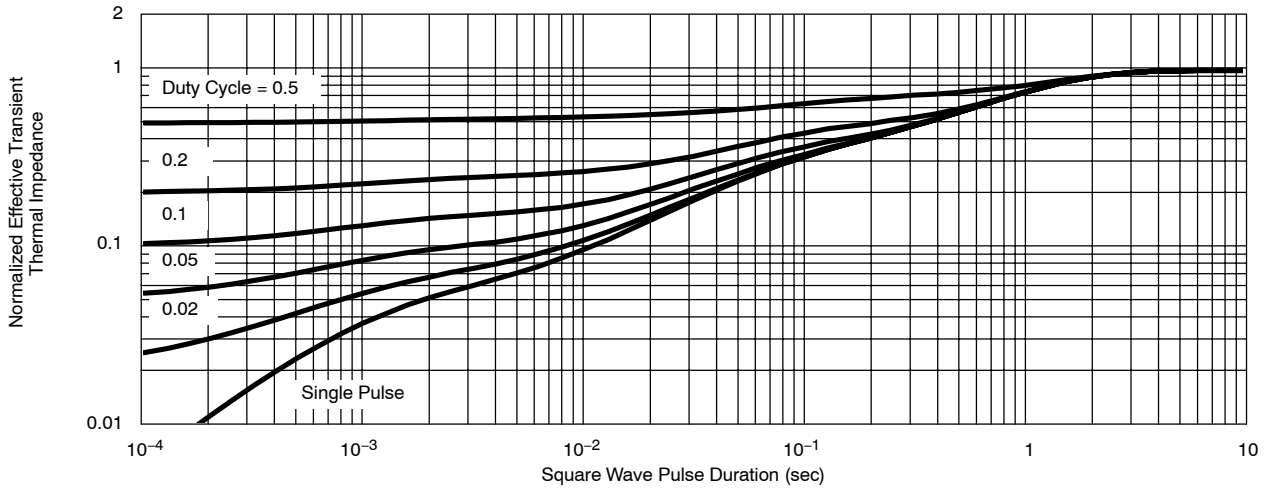


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ UNLESS NOTED)

Normalized Thermal Transient Impedance, Junction-to-Ambient (SC-75A)



Normalized Thermal Transient Impedance, Junction-to-Foot



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